

### General Description

The CMD240 and CMU240 uses Trench MOSFET technology that is uniquely optimized to provide the most efficient high frequency switching performance. Power losses are minimized due to an extremely low combination of RDS(ON) and Crss.

### Features

- RDS(ON)<4mΩ @ VGS=10V
- RDS(ON)<5mΩ @ VGS=4.5V
- Reliable and Rugged
- Lead Free

### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	40	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C <sup>1</sup>	Continuous Drain Current	80	A
I <sub>D</sub> @T <sub>C</sub> =100°C <sup>1</sup>	Continuous Drain Current	55	A
I <sub>DM</sub> <sup>2</sup>	Pulsed Drain Current	300	A
E <sub>AS</sub> <sup>3</sup>	Single Pulse Avalanche Energy	196	mJ
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation	150	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 175	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 175	°C

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-ambient (Steady-State)	---	50	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction -Case(Steady-State)	---	1	°C/W

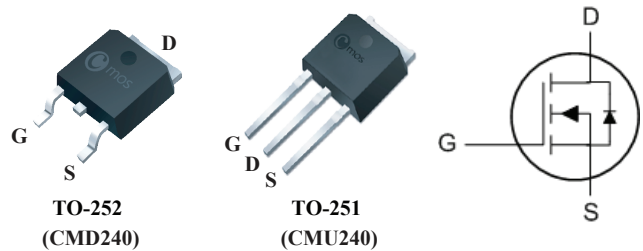
### Product Summary

BVDSS	RDSON	ID
40V	4mΩ	80A

### Applications

- Power Management in Note book
- LCD Display inverter
- DC/DC converter
- Load Switch

### TO-252/251 Pin Configuration



### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=30A$	---	---	4	m $\Omega$
		$V_{GS}=4.5V, I_D=20A$	---	---	5	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1	---	3	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=30V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	$\mu A$
		$V_{DS}=30V, V_{GS}=0V, T_J=55^\circ\text{C}$	---	---	5	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA
$g_{fs}$	Forward Transconductance	$V_{DS}=15V, I_D=11A$	---	20	---	S
$R_g$	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	---	1.2	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{DS}=20V, V_{GS}=10V, I_D=20A$	---	45	---	nC
$Q_{gs}$	Gate-Source Charge		---	9	---	
$Q_{gd}$	Gate-Drain Charge		---	7	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=20V, V_{GS}=10V, R_G=3\Omega$ $R_L=1\Omega$	---	15	---	ns
$T_r$	Rise Time		---	12	---	
$T_{d(off)}$	Turn-Off Delay Time		---	40	---	
$T_f$	Fall Time		---	11	---	
$C_{iss}$	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, f=1\text{MHz}$	---	7500	---	pF
$C_{oss}$	Output Capacitance		---	1000	---	
$C_{rss}$	Reverse Transfer Capacitance		---	90	---	

### Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=30A$	---	---	1	V

Note :

1. The maximum current rating is package limited.
2. Repetitive rating, pulse width limited by junction temperature  $T_J(\text{MAX})=175^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .
3. The EAS data shows Max. rating . The test condition is  $V_{DD}=20V, V_{GS}=10V, L=0.5\text{mH}, I_{AS}=28A$

This product has been designed and qualified for the consumer market.  
Cmos assumes no liability for customers' product design or applications.  
Cmos reserves the right to improve product design, functions and reliability without notice.